# **2019 Investor Relations**



will make the semiconductor industry prosper TechWing Company

## 2019.6

## **TechWing**

All financial data of TechWing (the "company") discussed in this presentation is based on K-GAAP and K-IFRS.

This presentation contains forward-looking statements relating to the company's future performance. These forward-looking statements reflect the company's forecasts for the future, not the past, and the beliefs of the company's management on what is achievable. These forward-looking statements include, but are not limited to, "anticipate," "project," "plan," and "expect."

These forward-looking statements are subject to significant changes in business conditions, and such uncertainties may lead to material differences between the information contained in the forward-looking statements and actual results.

In addition, all indicators contained herein are based on current market conditions and the company's management goals and policies. Thus, actual results may vary as a result of a number of factors including drastic changes in market and investment conditions, as well as revisions to the company's goals. We disclaim any liability whatsoever for any investment results arising from any use of this presentation and are not obliged to disclose new information.

The company includes information in this presentation according to a fair disclosure policy that strictly complies with KOSDAQ regulations. Therefore, please note that detailed estimates and sales prospects are not mentioned. Please refer to quarterly/biannual business reports for more information in detail.

will make the semiconductor industry prosper

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# **Chapter 1. Business Information**





## **1. Business Introduction**

## **Market leader in semiconductor equipment**

As a mechatronics company, TechWing provides the best semiconductor equipment to customers TechWing also provides customized solutions upon request

#### Chip level test handler

- Memory test handler
   64, 128, 256, 512, 768, 960 parallel
- Non-memory test handler
  - 8 & 16 parallel dual temp handler
  - 16~32 parallel tri temp handler



#### Module & SSD test handler

- Module handler
  - 16, 32, 128 parallel
  - System level testing solution
- SSD test handler - Standalone & Inline testing solution

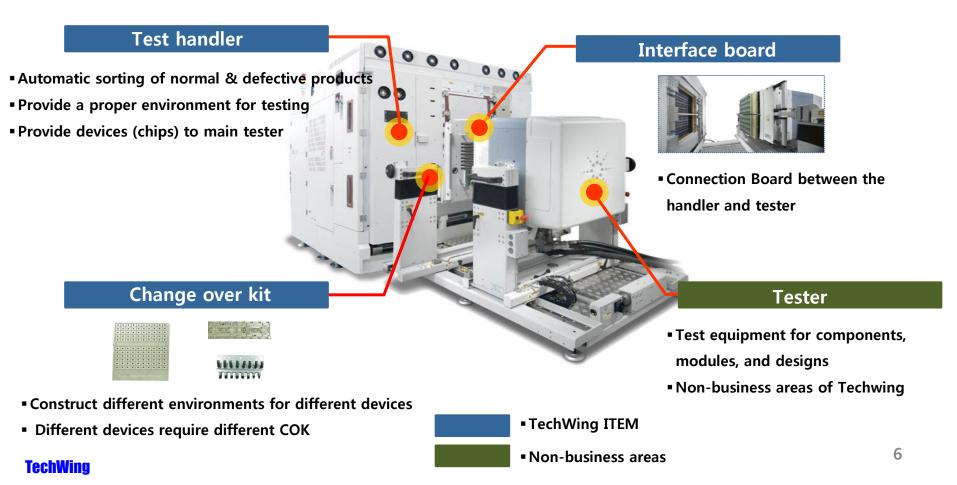


#### Others

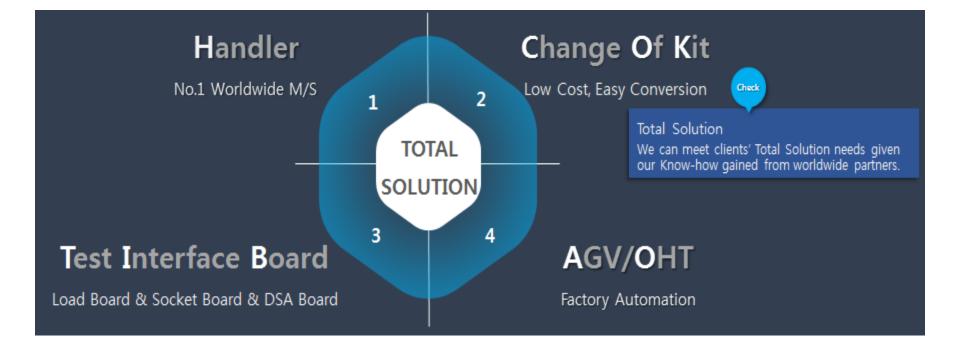
- Handler SLT, Strip, Tab
- Load board or DSA board
- Change Over Kit
- OHT, AGV

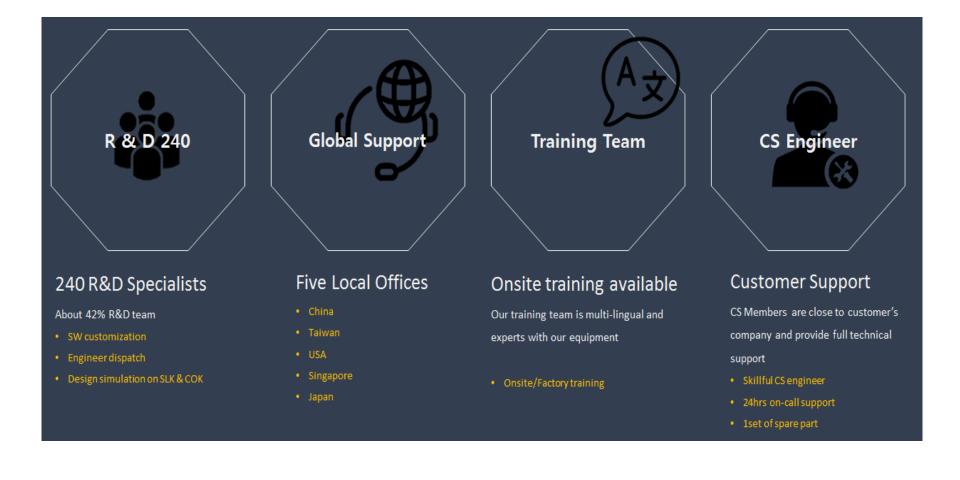


## "Testing equipment sorts devices into different categories based on the tester's results"

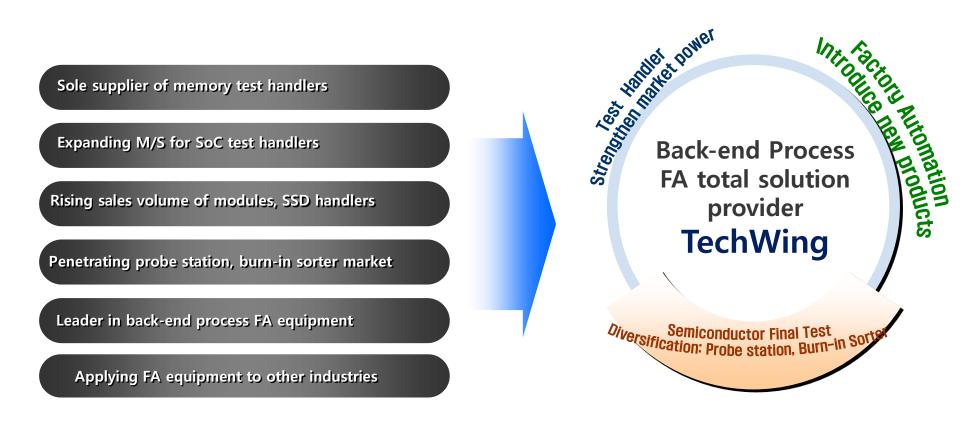


### Investor Relations 2019 3. Competitiveness: Total Solution





## "Expand test handler client base! Diversify factory automation equipment!"



**TechWing** 

## 5. Display Panel Inspection Equipment: ENC Technology

### "Goal of growth as leader in display panel inspection equipment- inspection development"

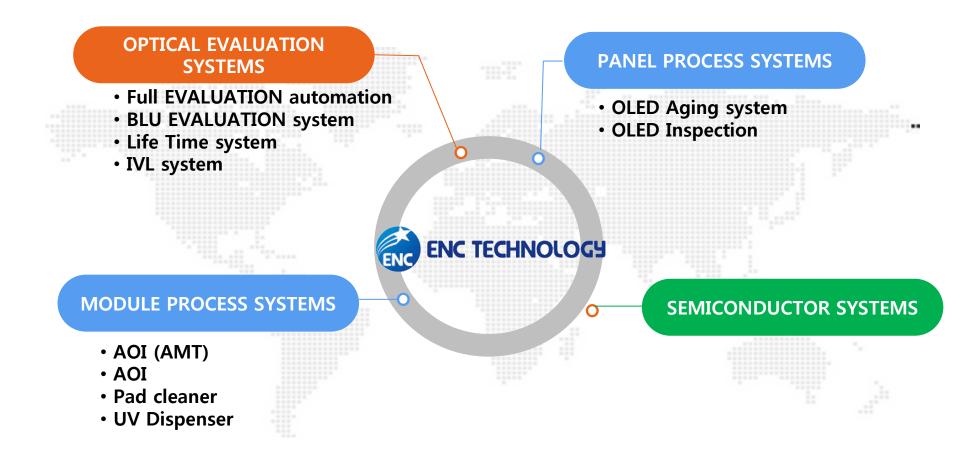


OEM for OLED equipment & part New inspection equipment development/sales

Continue to supply optical measurement equipment

#### **Investor Relations 2019**

## 5. Display Panel Inspection Equipment: ENC Technology



# **Chapter 2. Company Information**





### Investor Relations 2019 **1. Overview**

> HQ in Hwaseong



### Factory in Anseong



### Factory in Asan



- Business area
- : Semiconductor equipment
- Foundation : August 2002
- CEO
- Employees
- Headquarters
- Factory
  - Capacity

- : Yunsung Na : Approx. 600 (around 40% R&D)
- : Sales/Management/HR/Finance
- : Production/QA/Production R&D
- : 85,123m<sup>2</sup> factory floor space
- 1040 handlars ( ) . . .
- Install base : 1,940 handlers (updated on 31st December, 2018)

## Investor Relations 2019 2. TechWing's History



2004.12 Develop 256Para Memory Test Handler

2004.08 Acquire ISO 9901 and ISO 14001

2003.01 Develop 128 Para Memory Test Handler

2005~

2010

2002.08 Establish TechWing

2011~2015



Wing

START

2010.11 Acquire OHSAS 18001

2010.07 Expand Anseong Plant II

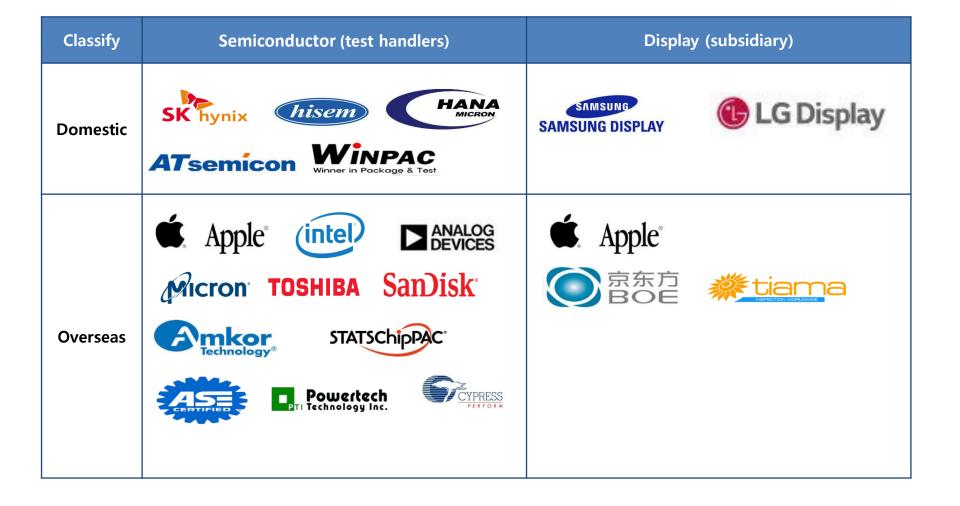
2010.06 Develop Module Handler

2009.02 Develop 512 para High Speed Test Handler

2006.12 Relocate factory to Hwaseong (now headquarters)

2018.01 Open new factory in Asan 2016.12 Receive \$100 million Export Tower Award 2016.02 Expand of Anseong Plant III





## Investor Relations 2019 4. Global Network



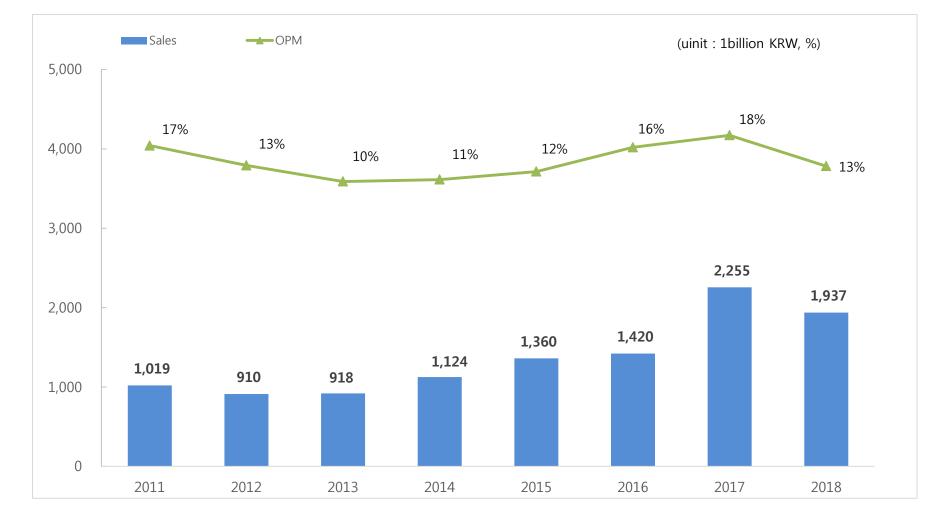
- ✓ 5 Local offices China, Japan, Singapore, Taiwan, USA
- ✓ Systematic training course by training team onsite training available
- ✓ Devoted support from Sales & CS

# **Chapter 3. Financial Highlight**





# Investor Relations 2019 1. Performance



#### **TechWing**

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## 2. Summary of financial statements (2016~2018)

#### Summary of Consolidated Balance Sheet

		(Unit : KRW mm)	
As of 31 December	2018	2017	2016
Current Asset	148,245	175,708	105,333
Non-current Asset	187,672	166,671	162,311
Total assets	335,917	342,380	267,645
Current Liabilities	121,317	150,247	84,210
Non-current Liabilities	50,933	39,506	76,020
Total Liabilities	172,250	189,753	160,230
Capital Stock	9,478	9,264	9,106
Capital Surplus	43,035	37,342	34,081
Other capital items	(7,869)	851	(2,705)
Retained Earnings	118,892	103,475	69,026
Non-controlling Interest	132	1,691	(2,094)
Total Stockholders' Equity	163,667	152,626	107,414

#### Summary of Consolidated Income Statement

2018		
	2017	2016
193,710	222,772	141,979
129,045	144,538	90,464
64,666	78,234	51,515
25,093	41,516	23,093
22,825	47,993	18,103
4,264	8,606	3,460
18,561	39,387	14,643
	129,045 64,666 25,093 22,825 4,264	129,045       144,538         64,666       78,234         25,093       41,516         22,825       47,993         4,264       8,606